TOSHIBA Field Effect Transistor Silicon N Channel MOS Type

# SSM3K16FS

# **High Speed Switching Applications Analog Switch Applications**

Suitable for high-density mounting due to compact package

Low on resistance:  $R_{on} = 3.0 \Omega$  (max) (@VGS = 4 V)

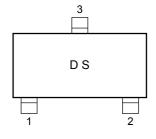
:  $R_{on} = 4.0 \Omega \text{ (max) } (@V_{GS} = 2.5 \text{ V})$ 

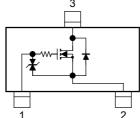
:  $R_{on} = 15 \Omega (max) (@V_{GS} = 1.5 V)$ 

## **Maximum Ratings (Ta = 25°C)**

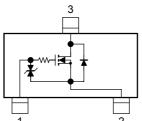
Characteristics		Symbol	Rating	Unit	
Drain-Source voltage		$V_{DS}$	20	V	
Gate-Source voltage		$V_{GSS}$	±10	V	
Drain current	DC	I <sub>D</sub>	100	mA	
	Pulse	I <sub>DP</sub>	200		
Drain power dissipation (Ta = 25°C)		P <sub>D</sub>	100	mW	
Channel temperature		T <sub>ch</sub>	150	°C	
Storage temperature range		T <sub>stg</sub>	-55~150	°C	

# **Marking**





#### Internal connections



#### **Handling Precaution**

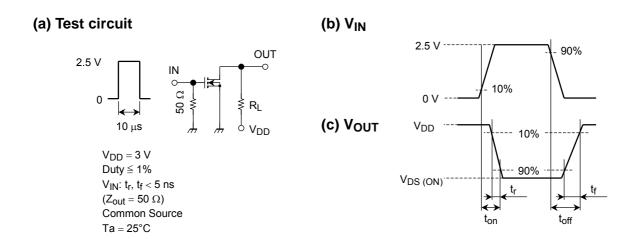
When handling individual devices (which are not yet mounting on a circuit board), be sure that the environment is protected against electrostatic electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

Unit: mm

#### **Electrical Characteristics (Ta = 25°C)**

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current		I <sub>GSS</sub>	$V_{GS}=\pm 10~V,~V_{DS}=0$	_	_	±1	μΑ
Drain-Source breakdown voltage		V (BR) DSS	$I_D = 0.1 \text{ mA}, V_{GS} = 0$	20	_	_	V
Drain cut-off currer	nt	I <sub>DSS</sub>	$V_{DS} = 20 \text{ V}, V_{GS} = 0$	_	_	1	μΑ
Gate threshold volt	age	V <sub>th</sub>	$V_{DS} = 3 \text{ V}, I_D = 0.1 \text{ mA}$	0.6	_	1.1	V
Forward transfer ad	dmittance	Y <sub>fs</sub>	V <sub>DS</sub> = 3 V, I <sub>D</sub> = 10 mA	40	_	_	mS
Drain-Source ON resistance		R <sub>DS (ON)</sub>	$I_D = 10 \text{ mA}, V_{GS} = 4 \text{ V}$	_	1.5	3.0	Ω
			$I_D = 10 \text{ mA}, V_{GS} = 2.5 \text{ V}$	_	2.2	4.0	
			I <sub>D</sub> = 1 mA, V <sub>GS</sub> = 1.5 V	_	5.2	15	
Input capacitance		C <sub>iss</sub>	$V_{DS} = 3 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$		9.3	_	pF
Reverse transfer capacitance		C <sub>rss</sub>	V <sub>DS</sub> = 3 V, V <sub>GS</sub> = 0, f = 1 MHz		4.5	_	pF
Output capacitance		Coss	$V_{DS} = 3 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	_	9.8	_	pF
Switching time	Turn-on time	t <sub>on</sub>	$V_{DD} = 3 \text{ V}, I_D = 10 \text{ mA}, \ V_{GS} = 0 \sim 2.5 \text{ V}$	_	70	_	ns
	Turn-off time	t <sub>off</sub>		_	125	_	

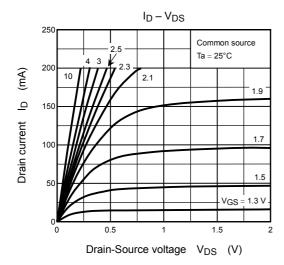
## **Switching Time Test Circuit**

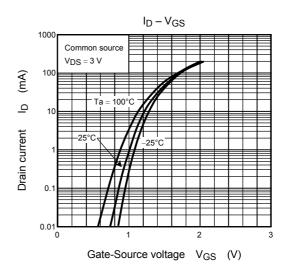


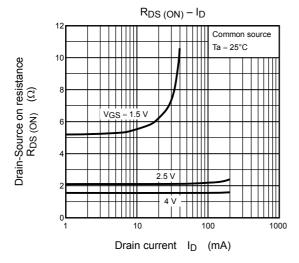
#### **Precaution**

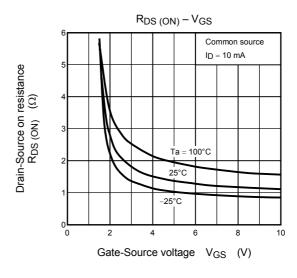
 $V_{th}$  can be expressed as voltage between gate and source when low operating current value is  $I_D$  = 100  $\mu A$  for this product. For normal switching operation,  $V_{GS}$  (on) requires higher voltage than  $V_{th}$  and  $V_{GS}$  (off) requires lower voltage than  $V_{th}$ . (Relationship can be established as follows:  $V_{GS}$  (off) <  $V_{th}$  <  $V_{GS}$  (on))

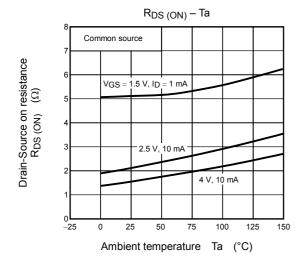
Please take this into consideration for using the device.  $V_{\rm GS}$  recommended voltage of 1.5 V or higher to turn on this product.

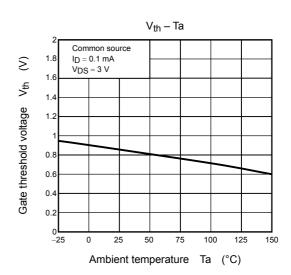


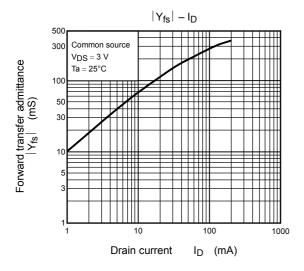


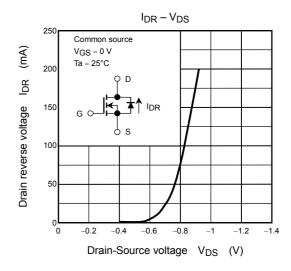


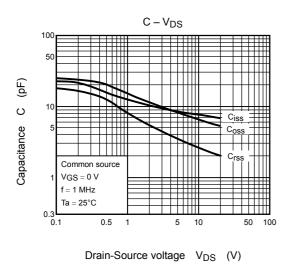


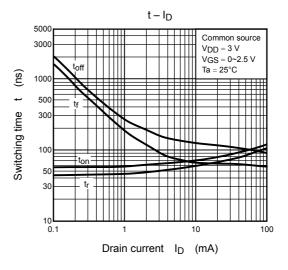


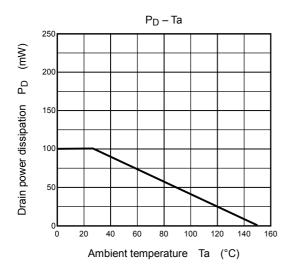












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